

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HAMIDREZA SHARIATI	02/18/2021
RECEIVING PARTY DATA	
Name:	SEMICONDUCTOR COMPONENTS INDUSTRIES, LLC
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17249078
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ATTORNEY DOCKET NUMBER:	ONS04228US
NAME OF SUBMITTER:	SHARRON CASTILLO
SIGNATURE:	/Sharron Castillo/
DATE SIGNED:	02/19/2021
Total Attachments: 2	
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ASSIGNMENT & AGREEMENT
ONS04228US

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I,

Name _____ of (City and State OR Country) _____

HAMIDREZA SHARIATI **WATERLOO CANADA**

agree to sell, assign, and transfer, and do hereby sell, assign, and transfer to Semiconductor Components Industries, LLC, a limited liability company of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives ("SCI"), the entire right, title, and interest in and to the inventions and discoveries as described, illustrated, and/or claimed in

Title: DELAYING RENDERING TIME FOR AUDIO COMPUTING SYSTEMS

Attorney Docket No.: ONS04228US

Serial No.: 17/249078

Filing Date: February 19, 2021

together with the entire right, title, and interest in and to the above listed application(s), and in and to any and all provisional, non-provisional, divisional, continuation, continuation-in-part, international, foreign, and any and all other applications related thereto, and also including any and all grants, issuances, letters patent, reissues, reexaminations, renewals, priority rights, and priority claims related to any of the foregoing, and any and all rights to collect past damages for infringement of any of the foregoing (the "Patent Rights").

I further authorize SCI to apply for and hold and maintain the Patent Rights throughout the world directly in its own name or any other name which SCI deems appropriate in its sole discretion, and to claim the priority of the filing date of the above listed application(s).

I agree that, when requested, I will, without charge to SCI, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing, maintaining, and enforcing the Patent Rights in any and all countries and for vesting title thereto in SCI or its nominees.

I represent and warrant that I have full right to convey the entire right, title and interest herein sold, assigned, and transferred, and that the Patent Rights hereby conveyed are free from all prior assignment, grant, mortgage, license, or other encumbrance to anyone other than SCI. I covenant and further warrant that I will not convey hereafter any part of the Patent Rights to anyone other than SCI or do any act whatsoever conflicting with this ASSIGNMENT & AGREEMENT.

I hereby authorize SCI or anyone it may properly designate to insert in this ASSIGNMENT & AGREEMENT the filing date and serial number of the above listed application(s) when ascertained. More than one counterpart of this ASSIGNMENT & AGREEMENT may be executed, each of which will be deemed an original.

By (Inventor signature): Mr. Shariati
Hamidreza Shariati

Signed on this 18 day of 02, 2021
day month year